SIM Card Connector

multicomp PRO

RoHS Compliant



Specification

Current Rating : 0.5 Amp max.

Dielectric Withstanding : 500V AC for one minute

Contact Resistance : $30m\Omega$ max.

Insulation Resistance : 1000MΩ min. at DC 500V

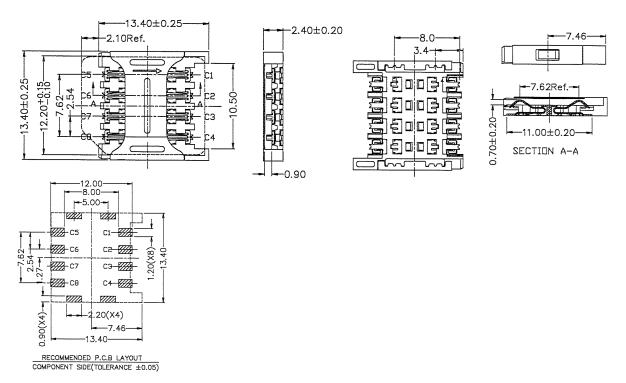
Operation Temperature : -25°C to +85°C

Materials

Housing : Hi-Temp. Plastic, Black

Terminal : Phosphor Bronze, Gold Plated Over all Shell : Stainless Steel SMT Area Gold Plated

Diagram



Dimensions: Millimetres

Part Number Table

| Description | Part Number |
|-------------------------|-------------|
| SIM Card CONN., 8P, SMT | MC002012 |

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